**Work Instructions for Edge Banding:**

1. Place Cartridge of 707.0 into pre heater. Pre-set at 125 °C.
2. Once melted, place heated cartridge into hand dispenser.
3. Dispense liquid PUR into hotmelt glue pot of edge banding machine. If there is still adhesive in cartridge, seal nozzle with KLEIBERIT 883.1 grease to prevent any moisture ingress. Glue can be used at a later stage.
4. Set edge banding glue pot and roller temperatures to between 120-130 °C.
5. Run production as normal:
   a. Coating weight target MDF = 100-120 g/m²
   b. Chipboard = 120-150 g/m²
6. At the end of shift remove glue pot and roller applicator and place into dry environment:
   a. Tank with Nitrogen blanket or
   b. Deep freeze unit set at 0 °C or below.
   Can be left over a weekend in these conditions.
7. Start-up at next production:
   a. Transfer glue pot and roller back onto edge banding machine
   b. Wait for unit to reach operating temperature
   c. If there is skin formation [Unlikely] peel off and dispose of. Molten adhesive below skin will be good to use.
8. Commence production.

Glue pots should be cleaned at least once a month using 822.5 cleaner.